Specifications for Approval

	Customer Part	No.:			
	Inhere Part No.	: \$1608BHYGT-001			
	Part Name: 160	08 黄绿光 LED			
	Spec Issue Date: 2018-07-05				
	Revision No.: A				
========	========				
	erewith the followi	ng information for your approv			
■ Sample		·	LED Dimension		
	l Characteristics Cu		Diagram		
■ Soldering	g recommendation				
Prepared by	: Lily	Checked by: Tom	Approved by: Wangxiaojun		
	07.05	D			
Date: 2018-0	07-05	Date: 2018-07-05	Date: 2018-07-05		
Date: 2018-(J7-05	Date: 2018-07-05	Date: 2018-07-05		
Date: 2018-0		Date: 2018-07-05	Date: 2018-07-05		
 Customer O		Date: 2018-07-05	Date: 2018-07-05		



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Features

1.6mm x 0.8mm SMD LED, 0.6mm thickness

Low power consumption

Wide view angle

Package: 4000pcs/reel

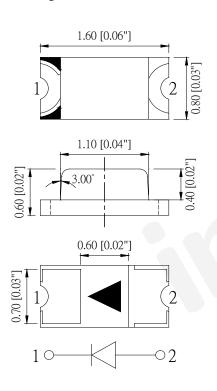
RoHS Compliant

Applications

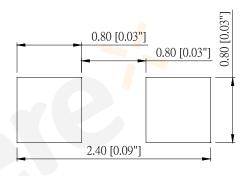
Ideal for back light and indicator

Various colors and lens types available

Package outlines



Recommend Pad Layout





Part No.	Emitted color	Dice Material	Lens color
S1608BHYGT-001	Yellow Green	AlGaInP	Water transparent

Notes:

All dimensions are in millimeters (inches);

Tolerances are ± 0.1 mm (0.004inch) unless otherwise noted.

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Absolute Maximum Ratings (Ta=25°C)

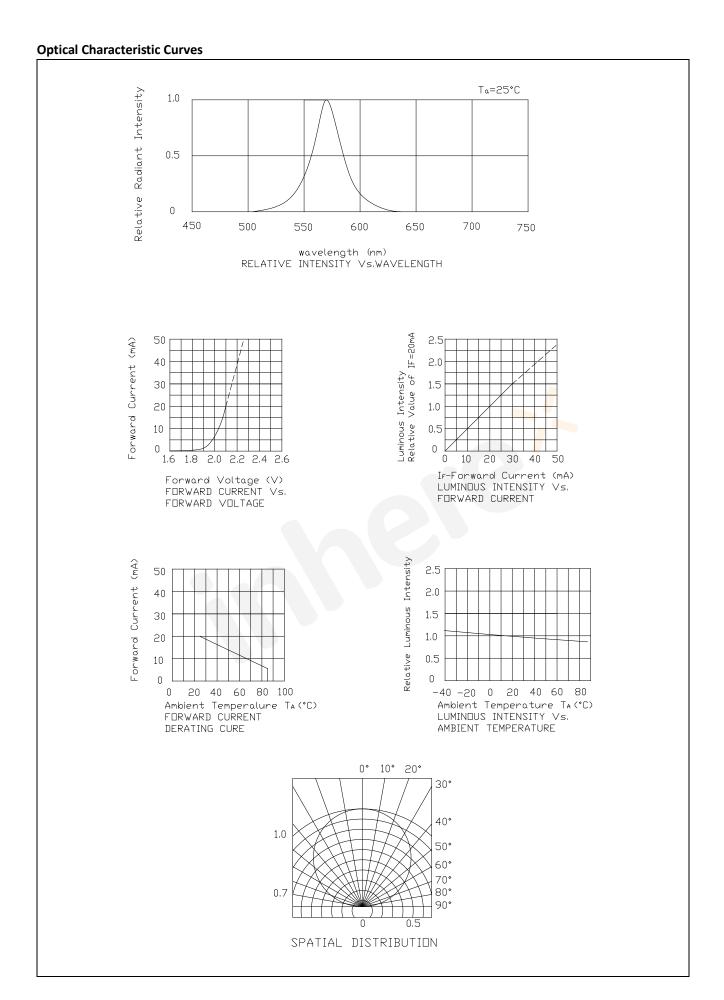
Parameter	Symbol	Value	Unit
Forward current	If	30	mA
Reverse voltage	Vr	5	V
Power dissipation	Pd	72	mW
Operating temperature	Тор	-40 ~+80	°C
Storage temperature	Tstg	-40 ~+85	°C
Peak pulsing current (1/8 duty f=1kHz)	Ifp	125	mA

Electro-Optical Characteristics (Ta=25°C)

	Test Sym Condition		Value			
Parameter		Symbol	Min	Тур	Max	Unit
Wavelength at peak emission	If=20mA	λр		573		nm
Spectral half bandwidth	If=20mA	Δλ		20		nm
Dominant wavelength	If=20mA	λd	566		576	nm
Forward voltage	If=20mA	Vf	1.8		2.4	V
Luminous intensity	If=20mA	lv	32	45		mcd
Viewing angle at 50% Iv	If=10mA	2 θ 1/2		120		Deg
Reverse current	Vr=5V	lr			10	μΑ

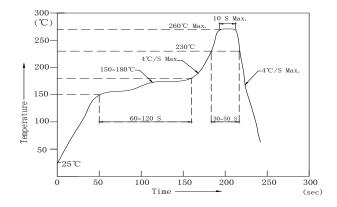
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Reflow Profile

■ Reflow Temp/Time



Notes:

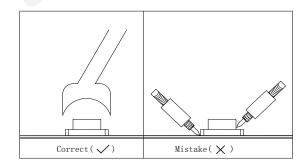
- 1. We recommend the reflow temperature 245 $^{\circ}$ C (±5 $^{\circ}$ C).the maximum soldering temperature should be limited to 260 $^{\circ}$ C.
- 2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

■Soldering iron

Basic spec is \leq 5sec when 320°C (±20°C). If temperature is higher, time should be shorter (+10°C \rightarrow -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 350°C.

■Rework

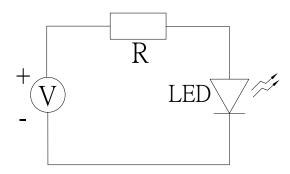
- 1. Customer must finish rework within 5 sec under 340°C.
- 2. The head of iron cannot touch copper foil
- 3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

Test circuit and handling precautions

■ Test circuit



■ Handling precautions

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: 5°C~30°C

2.2 Shelf life in sealed bag: 12 month at <5 $^{\circ}$ C $^{\sim}30$ $^{\circ}$ C and <30 $^{\circ}$ R.H. after the package is opened, the products should be used within a week or they should be keeping to stored at ≤20 R.H. with zip-lock sealed.

3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

- $3.1 60\pm3$ °C x($12\sim24$ hrs) and <5%RH, taped reel type
- 3.2 100±3 x (45min~1hr), bulk type
- 3.3 130±3 x (15~30min), bulk type

Test Items and Results of Reliability

Test Item	Test Conditions	Standard Test Method	Note	Number of Test
Reflow Soldering	Ta=260±5 ℃ ,Time=10±2S	JB/T 10845-2008	3times	0/22
Salt Atmosphere	Ta=35±3℃,PH=6.5~7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5°C 30±1min ↑→(25°C/5±1min)↓ 100±5°C 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=- 40 ± 5 $^{\circ}$ C \sim 100 ±5 $^{\circ}$ C, 15 \pm 1min dwell	GB/T 2423.22-2012	100cycles	0/22
High Humidity High Temp. Cycling	Ta=30 \pm 5 $^{\circ}$ C \sim 65 \pm 5 $^{\circ}$ C, 90 \pm 5%RH,24hrs/1cycle	GB/T 2423.4-2008	10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5℃,ψ(%)=85±5%RH	GB/T 2423.3-2006	1000hrs	0/22
High Temperature Storage Life	Ta=100±5℃,non-operating	GB/T 2423.2-2008	1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5℃,non-operating	GB/T 2423.1-2008	1000hrs	0/22
Life Test	Ta=26±5℃,@20mA, ψ(%)=25%RH∼55%RH		1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5˚C ,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5℃,@20mA	GB/T 2423.1-2008	1000hrs	0/22

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Forward Voltage Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
7	1.8	1.9	
8	1.9	2.0	
9	2.0	2.1	
A	2.1	2.2	V
В	2.2	2.3	
С	2.3	2.4	

Luminous Intensity Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
E	32	40	
F	40	50	
G	50	63	mcd
Н	63	80	
I	80	-(-	

Dominant wavelength Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
G9	566	568	
G10	568	570	
G11	570	572	nm
G12	572	574	
G13	574	576	

Group Name on Label (Example DATA: 9FG11 20)

DATA: 9FG11 20	Vf(V)	Iv (mcd)	λd (nm)	Test Condition
9→F→G11→20	2.0~2.1	40~50	570~572	IF=20mA

Notes:

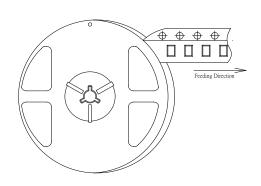
- 1. The tolerance of luminous intensity (Iv)is $\pm 15\,\%$.
- 2. The tolerance of dominant wavelength is ± 1 nm..
- 3. This specification is preliminary.
- 4. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

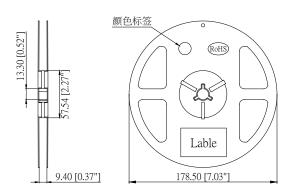
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1608 Series SMD Chip LED Lamps Packaging Specifications

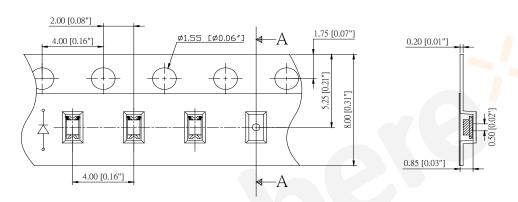
• Feeding Direction



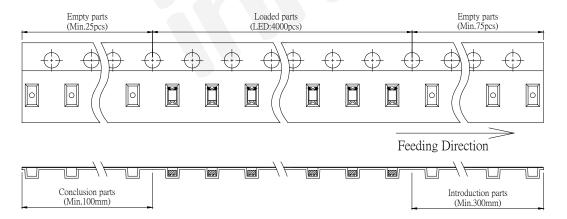




Dimensions of Tape (Unit: mm)



Arrangement of Tape



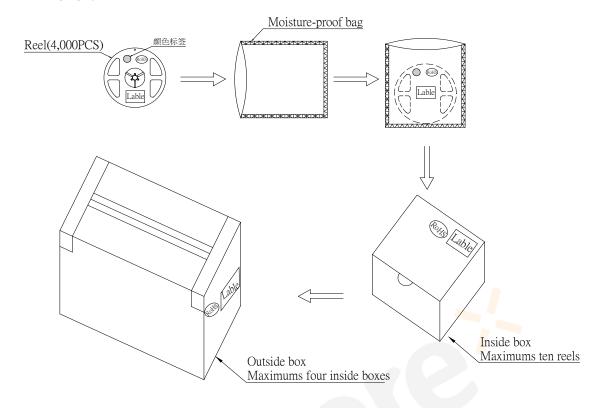
Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
- 4. 4,000pcs/Reel.

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1608 Series SMD Chip LED Lamps Packaging Specifications

Packaging specifications



Notes:

Reeled products (numbers of products are 4,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, ten moisture-proof bag of maximums (total maximum number of products are 40,000pcs) packed in an inside box (about size: 240x 230x 130mm) and four inside boxes of maximums are put in the outside box (about size: 545mm x 260mm x 250mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.

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